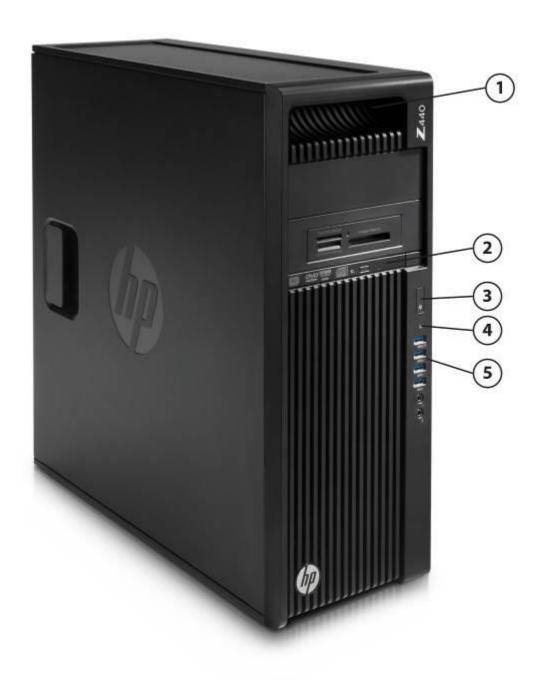
Overview

### **HP Z440 Workstation**



- 1. Integrated Front Handle
- 2. Dedicated 9.5mm Optical Drive Bay
- 3. Power Button

- 4. HDD Activity LED
- Front I/O: 4 USB 3.0 with Charging Port (topmost port),
   1 Microphone, 1 Headset

#### **Overview**



- 6. 2 External 5.25" Bays
- 7. 2 Internal 3.5" Bays
- 8. Fan and Front Card Guide Kit (optional)
- 9. 6 6Gb/s SATA Ports
- 10. Rear Grip
- 11. 525W, 85% Efficient Power Supply or 700W, 90% Efficient Power Supply

- 12. Rear I/O: Rear Power Button, 4 USB 3.0, 2 USB 2.0, PS/2 Ports, 1 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out
- 13. 8 DIMM Slots for DDR4 ECC Registered Memory
- 14. Intel Xeon Processors: E5-1600 v3 family (4C/6C/8C), E5-2600 v3 family (8C)
- 15. 2 PCIe x16 Gen 3 Slots
- 16. 1 PCIe x8 Gen 3, 1 PCIe x1 Gen 2, 1 PCIe x4 Gen 2, 1 PCI Slot

#### Overview

### **Overview**

Form Factor	Minitower
Operating Systems	Preinstalled:  Microsoft Windows 8.1 Pro 64-bit*  Microsoft Windows 8.1 (China) 64-bit  Microsoft Windows 8.1 Pro 64 downgrade to Windows 7 Professional 64-bit  Microsoft Windows 7 Professional (MSNA) 64-Bit*  HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)  Red Hat® Enterprise Linux Desktop (Paper license with 1 year support; no preinstalled OS)
	Notes: For detailed OS/hardware support information for Linux, see:  http://www.hp.com/support/linux_hardware_matrix

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology¹	TDP (W)
Intel® Xeon® E5-1680 v3 processor	8	3.2	20	2133	YES	YES	3, 6	140
Intel Xeon E5-1660 v3 processor	8	3.0	20	2133	YES	YES	3.5	140
Intel Xeon E5-2630 v3 processor	8	2.4	20	1866	YES	YES	2, 8	85
Intel Xeon E5-1650 v3 processor	6	3.5	15	2133	YES	YES	1, 3	140
Intel Xeon E5-1630 v3 processor	4	3.7	10	2133	YES	YES	1, 1	140
Intel Xeon E5-1620 v3 processor	4	3.5	10	2133	YES	YES	1, 1	140
Intel Xeon E5-1607 v3 processor	4	3.1	10	1866	NO	YES	N/A	140
Intel Xeon E5-1603 v3 processor	4	2.8	10	1866	NO	YES	N/A	140

<sup>1</sup>The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

**NOTE:** Although the Intel Xeon E5-2600 processor family supports dual processors, the HP Z440 Workstation does not support dual processor configurations.

Available Processors	
Disclaimers	Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: <a href="http://www.intel.com/products/processor_number/">http://www.intel.com/products/processor_number/</a> for details.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not



### Overview

	operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: <a href="http://www.intel.com/info/em64t">http://www.intel.com/info/em64t</a> for more information.  Quad-Core, Six-Core, and Eight-Core technologies are designed to improve performance of
	multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits. Check with software provider to determine suitability. Not all customers or software applications will necessarily benefit from use of these technologies.
Color	Jack Black
Convertibility	No
Expansion Slots (see	Slot 1 (top):
system board section for more details)	Full-height, Half-length
	Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 3: PCI Express Gen2 x4 with open-ended connector* Full-height, Full-length (with extender)
	Slot 4: PCI Express Gen3 x8 with open-ended connector* Full-height, Full-length (with extender)
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)
	* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.
Expansion Bays (see storage section for more details)	2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed) 2 external 5.25" bays
aetails)	<ul> <li>3rd and 4th 3.5" HDD each occupy one external bay</li> <li>3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier)</li> </ul>
	1 dedicated 9.5mm slim optical disk drive bay
Front I/O	4 USB 3.0, 1 Headset, 1 Microphone
Internal I/O	1 USB 2.0 ports available by a 2x5 header. Each 2x5 header supports either one HP Internal USB Port Kit (EM165AA) or one 15-in-1 Media Card Reader. 1 USB 3.0 port available by a 2x10 header.
Rear I/O	4 USB 3.0, 2 USB 2.0, 2 PS/2, 1 RJ-45 (NIC), 1 Audio Line-In, 1 Audio Line-Out. Serial supported with optional connector on PCI bracket cabled to system board connector.



### Overview

Interfaces Supported	15-in-1 Media Card Reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s). 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported). USB 2.0, USB 3.0
On-board RAID Support	RAID 0, 1, 10
Chassis Dimensions (H x W x D)	43.2 x 16.9 x 44.5 cm 17.0 x 6.65 x 17.5 in
Rack Dimensions	4U
Weight	Exact weights depend upon configuration. Minimum: 11.0 kg (24.3 lbs.) Standard: 13.5 kg (29.8 lbs.) Maximum: 17.5 kg (38.5 lbs.)
Temperature	Operating: 5° to 35°C (40° to 95°F) Non-operating: -40° to 60°C (-40° to 140°F)
Humidity	Operating: 8% to 85% relative humidity, non-condensing Non-operating: 8% to 90% relative humidity, non-condensing
Maximum Altitude (non- pressurized)	Operating: 3,048m (10,000ft) Non-operating: 9,144m (30,000ft)
Power Supply	ENTRY 525 watts wide-ranging, active Power Factor Correction, 85% Efficient, with no graphics power cable 525w PSU will support up to 75w of graphics only (no graphics dongles)  The Z440 525W power supply efficiency report can be found at this link: (TBD)  HIGH-END 700 watts wide-ranging, active Power Factor Correction, 90% Efficient, with two graphics power cables 700w PSU will support up to 225w of graphics  The Z440 600W power supply efficiency report can be found at this link: (TBD)
Workstation ISV Certifications	See the latest list of certifications at <a href="http://www.hp.com/united-states/campaigns/workstations/partnerships.html">http://www.hp.com/united-states/campaigns/workstations/partnerships.html</a>



#### **Supported Components**

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel Xeon E5-1600 v3 Series CPU				
	Intel Xeon E5-1680 v3 3.2 2133 8C CPU	Υ	N		
	Intel Xeon E5-1660 v3 3.0 2133 8C CPU	Υ	N		
	Intel Xeon E5-1650 v3 3.5 2133 6C CPU	Υ	N		
	Intel Xeon E5-1630 v3 3.7 2133 4C CPU	Υ	N		
	Intel Xeon E5-1620 v3 3.5 2133 4C CPU	Υ	N		
	Intel Xeon E5-1607 v3 3.1 1866 4C CPU	Υ	N		
	Intel Xeon E5-1603 v3 2.8 1866 4C CPU	Υ	N		
	Intel Xeon E5-2600 v3 Series CPU				
	Intel Xeon E5-2630 v3 2.4 1866 8C CPU	Υ	N		

<sup>\*</sup>Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Monitors /			Option	_
Displays	Factory	Option	Kit Part	Support
	Configured	Kit	Number	Notes

HP Z Display Z30i 30-inch IPS LED Backlit Monitor

HP Z Display Z27i 27-inch IPS LED Backlit Monitor

HP Z Display Z24i 24-inch IPS LED Backlit Monitor

HP Z Display Z23i 23-inch IPS LED Backlit Monitor

HP Z Display Z22i 21.5-inch IPS LED Backlit Monitor

HP DreamColor Z27x Professional Display

HP DreamColor Z24x Professional Display

Supported by all operating systems available from HP Screen size measured diagonally

### Storage / Hard Drives

SAS Hard Drives	SAS Hard Drives for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
		comiguica			
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA	
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA	
	HP 1.2TB SAS 10K SFF HDD	Υ	Υ	E2P04AA	
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA	
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA	

#### **NOTES:**

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 3.5-inch 15K rpm SAS drives: 300, 600 GB; 2.4 TB max



Up to (4) 2.5-inch 10K rpm SAS drives: 300, 600 GB, 1.2 TB; 4.8 TB max

SAS controller add-in card required

3rd and 4th SFF SAS HDDs will be automatically installed into a single 2:1 5.25" external bay adapter

Removable Boot Drive option

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA	
	500GB SATA 7.2K SED SFF HDD	Υ	N		

#### **NOTES:**

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 3.0, 4.0\* TB; 16.0 TB max

Up to (1) 2.5-inch SATA Self-Encrypting Drive (SED): 500 GB Opal 1

Removable Boot Drive option

\*4TB drive planned to be available late 2014

#### **SATA Solid State Drives**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Solid State Drives (SSDs) for Workstations				
HP 128GB* SATA 6Gb/s SSD	Υ	Υ	A3D25AA	
HP 256GB* SATA 6Gb/s SSD	Υ	Υ	A3D26AA	
HP 512GB* SATA 6Gb/s SSD	Υ	Υ	D8F30AA	
HP 1TB SATA* 6Gb/s SSD	Υ	Υ	F3C96AA	
HP 256GB SATA* 6Gb/s SED SSD	Υ	N		
Intel Pro 1500 180GB SATA SSD	Υ	Υ	F5Z70AA	
Samsung Enterprise 480GB* SATA SSD	Υ	Υ	TBD	
Samsung Enterprise 240GB* SATA SSD	Υ	Υ	F0W94AA	

#### **NOTES:**

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (4) 2.5-inch 6Gb/s SATA Solid State Drives: 128, 256, 512 GB, 1 TB; 4.0 TB max

Up to (1) 2.5-inch 6Gb/s SATA Self-Encrypting Solid State Drive (SED SSD): 256 GB Opal 2

Up to (4) 2.5-inch Intel Pro 1500 6Gb/s SATA Solid State Drive: 180 GB; 720 GB max



0-4:--

E0X20AA

Note 2

### **Supported Components**

Up to (4) 2.5-inch Samsung Enterprise 6Gb/s SATA Solid State Drives: 240, 480 GB; 1.9 TB max

3rd and 4th SSDs will be automatically installed into a single 2:1 5.25" external bay adapter

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	PCIe SSDs for HP Workstations				
	HP Z Turbo Drive 512GB SSD	Υ	Υ	G3G89AA	
	HP Z Turbo Drive 256GB SSD	Υ	Υ	G3G88AA	
	NOTES:				

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to (2) PCI Express Solid State Drives: 256, 512 GB; 1.0 TB max

PCIe SSDs are not available with SAS controller and/or HDDs

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 6.0 Gb/s Controller				
	Integrated SATA 6.0 Gb/s Controller	Υ	N		Six Ports
	Factory integrated RAID on motherboard for SATA drives				
	RAID 0 Configuration – Striped Array	Υ	N		Note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	N		Note 1
	RAID 1 Configuration – Mirrored Array	Υ	N		Note 1
	RAID 10 Configuration - Striped/Mirrored Array	Υ	N		Note 1
	LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card				

SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit

http://www.hp.com/support/linux\_hardware\_matrix for RAID capabilities with Linux.

All drives must be identical in type and capacity.

LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card

RAID arrays greater than 2 TB are fully supported.

**NOTE 1:** Requires hard drives with identical speed, capacity, and interface. Specific user-configured hardware SAS RAID configurations are supported on this Linux system. For details, please visit <a href="http://www.hp.com/support/linux\_hardware\_matrix">http://www.hp.com/support/linux\_hardware\_matrix</a>

NOTE 2: Specific user-configured hardware SAS RAID configurations are supported on this Linux system.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume.

For details, please visit http://www.hp.com/support/linux\_hardware\_matrix



### **Graphics**

		Option		Option		Supp	orted
	Factory Configured	Option Kit	Kit Part	Support Notes	# of cards	Mixed?	
Professional 2D	Connigureu	KIL	Nullibel	Support notes	carus	Mixeu:	
NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA	Note 1	3		
NVIDIA NVS 315 1GB Graphics	Υ	Υ	E1U66AA	Note 1	3		
NVIDIA NVS 510 2GB Graphics	Υ	Υ	C2J98AA	Note 2	2		
<b>Graphics Cable Adapters</b> HP DisplayPort to Dual Link DVI Adapter	Υ	Υ	NR078AA		1		
HP DisplayPort To DVI-D Adapter	Υ	Υ	FH973AA		1		
HP DisplayPort To DVI-D Adapter (2- Pack)	Υ	N			1		
HP DisplayPort To DVI-D Adapter (4- Pack)	Υ	N			1		
HP DisplayPort To DVI-D Adapter (6- Pack)	Υ	N			1		
HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA		1		
HP DisplayPort To VGA Adapter 2nd	Υ	N			1		
Entry 3D							
NVIDIA Quadro K620 2GB Graphics	Υ	Υ	J3G87AA		2		
NVIDIA Quadro K420 1GB Graphics	Υ	Υ	J3G86AA		2		
Mid-range 3D							
NVIDIA Quadro K2200 4GB Graphics	Υ	Υ	J3G88AA	Note 5	2		
AMD FirePro W2100 2GB Graphics	Υ	Υ	J3G91AA		2		
AMD FirePro W5100 4GB Graphics	Υ	Υ	J3G92AA	Note 5	1		
High End 3D							
NVIDIA Quadro K4200 4GB Graphics	Υ	Υ	J3G89AA	Notes 3, 4	1		
NVIDIA Quadro K5200 8GB Graphics	Υ	Υ	J3G90AA	Notes 3, 4	1		
NVIDIA Quadro K6000 12GB Graphics	Υ	Y	C2J96AA	Notes 3, 4	1		

**Note 1:** When configuring with a 3rd NVS 310 or 315--the configuration requires the HP Z4 Fan and Front Card Guide Kit, which is available both CTO (G8T99AV) and AMO (J9P80AA).

Note 2: If 1st graphics card is NVS 510 then 2nd graphics card must be NVS 510 or NVS 310.

**Note 3:** Configuration requires the HP Z4 Fan and Front Card Guide Kit, which is available both CTO (G8T99AV) and AMO (J9P8OAA).

Note 4: Supported on 700W PSU chassis only.

Note 5: Dual graphics configuration supported on 700W PSU chassis only.

High Performance GPU		Option Kit				
Computing		Factory Configured	Option Kit	Part Number	Support Notes	
	NVIDIA Tesla K40 Workstation Conrocessor	٧	V	F448844	Notes 1 2 3	

NOTE 1: This device does not have an operational graphics output.
Tesla K40 configurations require the addition of either NVIDIA Quadro K620 1st graphics or NVIDIA Quadro K2200 1st graphics. Configurations available early 2015.



NOTE 2: All Tesla configurations require the HP Z4 Fan and Front Card Guide Kit, which is available both CTO (G8T99AV) and AMO (J9P80AA).

NOTE 3: Supported on 700W PSU chassis only.

Memory CTO		Option Kit Part Number	Support Notes
	DDR4-2133 ECC Registered DIMMs		
	16GB DDR4-2133 ECC Registered RAM	J9P83AA	1,2,3
	8GB DDR4-2133 ECC Registered RAM	J9P82AA	1,2,3
	4GB DDR4-2133 ECC Registered RAM	J9P81AA	1,2,3

#### **NOTES:**

For details on the supported memory configurations on the HP Z440 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 4 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If an 1866MHz capable CPU is used in the system, the maximum speed the memory will run at is 1866MHz, regardless of the specified speed of the memory.

**NOTE 1:** ONLY registered DDR4 DIMMs are supported.

DDR3 DIMMs ARE NOT SUPPORTED.

**NOTE 2:** Configurations of greater than 4x memory DIMMs require the HP Z440 Memory Cooling Solution, which is available both CTO (J2R51AV) and AMO (J2R52AA).

#### **Multimedia and Audio Devices**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Realtek HD ALC221 Audio	Υ	N		

### **Optical and Removable Storage**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim SuperMulti DVD Writer	Υ	Υ	K3R64AA	
HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA	Note 1
HP 9.5mm Slim BDXL Blu-Ray Writer	Υ	Υ	K3R65AA	Note 2
HP 15-in-1 Media Card Reader				
HP 15-in-1 Media Card Reader	Υ	Υ	G1S79AA	
HP DX115 Removable Drive Enclosure				
HP DX115 Removable HDD Carrier	N	Υ	NB792AA	
Astrological and the second process of the s	:		DVD to	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other



copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

**NOTE 1:** Not supported as a 2nd drive option.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		Factory Configured	Option Option Kit Part Kit Number		Support Notes
	HP IEEE 1394b FireWire® PCIe Card	Υ	Υ	NK653AA	
	HP Thunderbolt™ 2 PCIe 1-port I/O Card	Υ	Υ	F3F43AA	Note 1

NOTE 1: Compatible with NVIDIA Quadro K620, K2200, K4200, and K5200 only.

### **Networking and Communications**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Intel I218LM PCIe GbE Controller	Υ	N		
Intel Ethernet I210-T1 PCIe NIC	Υ	Υ	E0X95AA	
HP X520 10GbE Dual Port Adapter	Υ	Υ	C3N52AA	
HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	
HP 361T PCIe Dual Port Gigabit NIC	N	Υ	C3N37AA	Note 1
Intel 7260 802.11 a/b/g/n PCIe WLAN NIC	N	Υ	F2P07AA	

**NOTE 1:** "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

\*Wireless access point and internet service required. Availability of public wireless access points limited.

### **Racking and Physical Security**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Solenoid Hood Lock & Hood Sensor	Υ	Υ	DE618A	
HP Business PC Security Lock Kit	N	Υ	PV606AA	
HP xw4/Z2/Z4 Depth Adjustable Fixed Rail Rack Kit	N	Υ	WH340AA	

Input Devices	Option Kit			
	Factory	Option	Part	Support
	Configured	Kit	Number	Notes



### **Supported Components**

HP PS/2 Keyboard	Υ	Υ	QY774AA
HP USB Keyboard	Υ	Υ	QY776AA
HP USB Smart Card Keyboard	Υ	Υ	E6D77AA
HP Wireless Keyboard and Mouse	Υ	Υ	QY449AA
HP PS/2 Mouse	Υ	Υ	QY775AA
HP USB Optical Mouse	Υ	Υ	QY777AA
HP USB 1000dpi Laser Mouse	Υ	Υ	QY778AA
HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA
HP SpaceMouse Pro USB 3D Input Device	N	Υ	B4A20AA
HP SpacePilot Pro 3D USB Intelligent Controller	N	Υ	WH343AA

#### **Other Hardware**

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Z440 Memory Cooling Solution	Υ	Υ	J2R52AA	Note 1
HP Z440 Fan and Front Card Guide Kit	Υ	Υ	J9P80AA	Note 2
HP Internal USB Port Kit	N	Υ	EM165AA	Note 3
HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	Note 4
HP Serial Port Adapter	Υ	Υ	PA716A	
HP Optical Bay HDD Mounting Bracket	N	Υ	NQ099AA	
HP Power Cord Kit	N	Υ	DM293A	
HP Workstation Mouse Pad	Υ	N		Japan only
HP ENERGY STAR® Enabled Configuration	Υ	N		

**Note 1:** The HP Z440 Memory Cooling Solution is available to add to any configuration for improved system cooling, but is required for memory configurations using greater than 4x DIMMs.

**Note 2**: Required for the following graphics configurations:

- 3 x NVIDIA NVS 310/315
- 1 x NVIDIA Quadro K4200
- 1 x NVIDIA Quadro K5200
- 1 x NVIDIA Quadro K6000

Note 3: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Note 4: No hot plug / hot swap supported

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		Note 1
	HP Remote Graphics Software (RGS) 6.0	Υ	Υ		Note 2
	MS Office Home & Business 2013	Υ	N		Note 3
	Cyberlink PowerDVD and Power2Go	Υ	N		
	Foxit PhantomPDF Express	Υ	N		

**NOTE 1:** Available as a free download here: www.hp.com/go/performanceadvisor

**NOTE 2:** Supported operating systems:



#### **Supported Components**

- Windows 7 Professional 32/64
- Windows 8 Professional 32/64
- RHEL v6.5
- SLED 11 SP3

For more information, go to: <a href="www.hp.com/qo/rqs">www.hp.com/qo/rqs</a> **NOTE 3**: Must select as a Configure to Order option.

### **Operating Systems**

**Support Notes** 

Windows 8.1 Pro 64-bit\*

Windows 7 Professional 64-bit (available through downgrade rights from

Windows 8.1 64-bit)\*\*

Windows 7 Professional (MSNA) 64-Bit\*

(National Academic)

**HP Linux Installer Kit** 

Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)

Note 1

- \* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See http://www.microsoft.com.
- \*\* This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

**NOTE 1:** This second OS must be ordered with the HP Linux Installer Kit as the first OS.

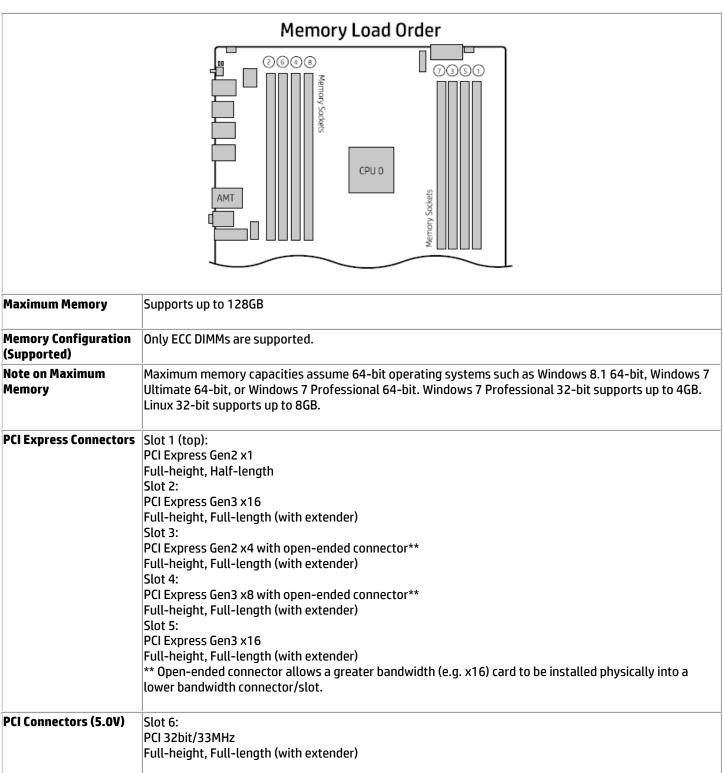
### **System Technical Specifications**

System Board	
System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches
Processor Socket	Single LGA2011 R3
Chipset	Intel® C612 Chipset
Super I/O Controller	Nuvoton NPCD379H (SIO-12)
Memory Expansion Slots	8 DDR4 memory slots
Memory Type Supported	DDR4, RDIMM (Registered), ECC: 4GB, 8GB and 16GB
Memory Modes	Channel Interleaved
Memory Speed Supported	1600MHz, 1866MHz and 2133MHz
Memory Protection	ECC available on data, parity on address and command
Memory	
Memory Configuration Table	Please refer to the table below for details on how supported memory configurations are installed in your system.
	* For 32 bit operating systems, there is a memory limit of 4GB.
	~ Although technically possible, these configurations are not available to order at this time.

	CPU O									
	Front Slots						Rear Slots			
	Notes	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6	DIMM7	DIMM8	Rating
4GB	*	4GB								Fair
8GB		4GB 8GB							4GB	Good Fair
12GB		4GB		4GB					4GB	Better
16GB		4GB 8GB		4GB			4GB		4GB 8GB	Best Good
32GB		4GB 8GB 16GB	4GB	4GB 8GB	4GB	4GB	4GB 8GB	4GB	4GB 8GB 16GB	Best Best Good
48GB	2	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	Best
64GB		8GB 16GB	8GB	8GB 16GB	8GB	8GB	8GB 16GB	8GB	8GB 16GB	Best Best
96GB	~	16GB	8GB	16GB	8GB	8GB	16GB	8GB	16GB	Best
128GB		16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	Best

For a detailed diagram, please refer to the label located on the inside of the system side panel.







Supported Drive Interfaces	SATA	2 SATA @6Gb/s, supports RAID 0,1 and NCQ. 4 sSATA @6Gb/s, Supports RAID 0,1,10 and NCQ. Factory integrated RAID is Microsoft Windows only.
	Serial Attached SCSI	Requires Optional PCIe card
	Integrated RAID	SATA: RAID 0, 1 SSATA: RAID 0, 1, 10 RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead.
	Integrated Graphics	No
	Network Controller	Integrated Intel I-218 Gbit LAN  Supports the following management functionalities: Intel AMT9.1, TXT, DASH 1.1, WOL, VLAN, Teaming and PXE 2.1
	External SATA (eSATA)	Supported on all SATA and sSATA ports configurable with optional eSATA* cable kit * hot plug / hot swap not supported with eSATA
	IDE connector	No
	Floppy connector	No
	Serial	1 internal header
	2nd Serial	No
	Parallel	No
	AUX IN (audio)	No
IEEE 1394 Connector(s)	Front	None
	Rear	2 IEEE 1394b (requires optional PCIe card)
	Internal	None
USB Connector(s)	Front	4 USB 3.0
	Rear	4 USB 3.0 2 USB 2.0



	Internal		header suppoi (EM165AA) or	1 USB 2.0 port available by a 2x5 header. Each 2x5 header supports either one HP Internal USB Port Kit (EM165AA) or one 15-in-1 Media Card Reader. 1 USB 3.0 port available by a 2x10 header.			
HD Integrated Audio	Realtek ALC221						
Flash ROM	Yes						
CPU Fan Header	Yes						
Chassis Fan Header	1 Rear System Chassis Fan H	eader					
Front PCI Fan Header	Yes						
Front Control Panel/Speaker Header	Yes						
CMOS Battery Holder - Lithium	Yes						
Integrated Trusted Platform Module	Infineon TPM 1.2 Certified						
Power Supply Headers	Yes						
Power Switch, Power LED & Hard Drive LED Header	Yes	es					
Clear Password Jumper	Yes						
Serial Port	1 internal header						
Parallel Port	No						
Keyboard/Mouse	USB or PS/2						
Power Supply							
Power Supply		700W 90% Efficie (Wide-Ranging	•	525W 85% Efficient, Custom PSU (Wide-Ranging, Active PFC)			
Operating Voltage Rang	e	90–26	9 VAC	90–269 VAC			
Rated Voltage Range		100-240 VAC	118 VAC	100-240 VAC	118 VAC		
Rated Line Frequency		50-60 Hz	400 Hz	50–60 Hz	400 Hz		
Operating Line Frequenc	y Range	47–66 Hz	393–407 Hz	47–66 Hz	393–407 Hz		
Rated Input Current		100-240V @ 9.5A	118V @ 9.5A	100-240V @ 7A	118V @ 7A		
- Heat Dissipation (Configuration and softwar	re dependent)	Typical = 1648 btu/ Max = 2746 btu/h	-	Typical = 1311 btu/ Max = 2185 btu/h	•		
Power Supply Fan		92x25 mm va	riable speed	92x25 mm va	riable speed		
ENERGY STAR Qualified (Configuration dependen	ed Vos Vo				·		
80 PLUS® Compliant		Yes, 90% The Z440 700W efficiency report ca link:	power supply In be found at this	Yes, 85% The Z440 525W efficiency report ca link:	I power supply an be found at this		
FEMP Standby Power Co (<2W in S5 – Power Off)	mpliant @115V	Ye	S	Ye	25		



EuP Compliant @ 230V (<0.5 W in S5 – Power Of	f)	Yes	Yes			
CECP Compliant @ 220V (<4W in S3 – Suspend to RAM)		Yes; Configuration dependent	Yes; Configuration dependent			
Power Consumption in s (as defined by ENERGY S (Instantly Available PC)	leep mode TAR) – Suspend to RAM (S3)	<15w	<15w			
Built-in Self Test LED		Yes	Yes			
Surge Tolerant Full Rang (withstands power surg		Yes	Yes			
Hood Lock Header	Yes					
Hood Sensor Header	Yes					
Memory Fan	1 Memory Fan Header					



**System Technical Specifications** 

### **SYSTEM CONFIGURATION**

Example	Processor	1x Intel Xeon	E5-1603 v3 (Qı	uad-Core)			
Configuration #1	Memory	1x 4GB DDR4-	-2133 Register	red RAM			
ENERGY STAR	Graphics	1x NVIDIA NV	5 310				
QUALIFIED	Disks / Optical	1x 500GB SAT	A 7200 / 1x Sli	m DVD-ROM S	ATA		
	Power Supply	525W 85% Cu	stom PSU				
	Other	N/A					
		115	VAC	230	VAC	100	VAC
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	51.	51.01 W		29 W	53.0	01 W
	Windows Busy Typ(S0)	112.95 W		110.	62 W	113.96 W	
	Windows Busy Max (S0)	117.16 W		112.45 W		114.67 W	
	Sleep (S3)	2.34 W	2.19 W	2.54 W	2.41 W	2.33 W	2.19W
	Off (S5)	0.825 W	0.784 W	1.024 W	0.985 W	0.851 W	0.772 W
	Zero Power Mode (ErP)	0.1	90 W	0.382 W		0.178 W	
		115	S VAC	230	VAC	100	VAC
<b>Heat Dissipation</b>		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	174.0	5 Btu/hr	175.02	Btu/hr	180.89 Btu/hr	
	Windows Busy Typ(S0)	385.39	9 Btu/hr	377.4	Btu/hr	388.83	Btu/hr
	Windows Busy Max (S0)	399.7	5 Btu/hr	383.68	Btu/hr	391.25	Btu/hr
	Sleep (S3)	7.98 Btu/hr	7.49 Btu/hr	8.68 Btu/hr	8.21 Btu/hr	7.95 Btu/hr	7.47 Btu/hr
	Off (S5)	2.18 Btu/hr	2.67 Btu/hr	3.49 Btu/hr	3.36 Btu/hr	2.90 Btu/hr	2.63 Btu/hr
	Zero Power Mode (ErP)	0.649	Btu/hr	1.303	Btu/hr	0.607	Btu/hr

Example	Processor	1x Intel Xeon	E5-1630 v3 (Q	uad-Core)				
Configuration #2	Memory	2x 4GB DDR4–2133 Registered RAM						
ENERGY STAR	Graphics	1x NVIDIA Qu	adro K620					
QUALIFIED	Disks / Optical	1x 500GB SA	ΓΑ 7200 / 1xSlir	n DVD-ROM S	ATA			
	Power Supply	700W 90% Cu	700W 90% Custom PSU					
	Other	N/A						
Energy Consumption		115 VAC		230	VAC	100 VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	62.	25 W	61.5	50 W	62.31 W		
	Windows Busy Typ(S0)	112	.48 W	111.39 W		113.48 W		
	Windows Busy Max (S0)	136	.87 W	129.05 W		113.64 W		
	Sleep (S3)	2.25 W	2.147 W	2.41 W	2.30 W	2.25 W	2.14 W	
	Off (S5)	0.821 W	0.775 W	1.024 W	0.925 W	0.842 W	0.769 W	
	Zero Power Mode (ErP)	0.1	67 W	0.30	6 W	0.15	58 W	
						ı		
		11	5 VAC	230 VAC		100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	



(Btu/hr)	Windows Idle (S0)	212.43 Btu/hr		209.85 Btu/hr		212.62 Btu/hr	
	Windows Busy Typ(S0)	383.78	8 Btu/hr	380.06	Btu/hr	387.19	Btu/hr
	Windows Busy Max (S0)	467.00	0 Btu/hr	440.32	Btu/hr	387.74	Btu/hr
	Sleep (S3)	7.69 Btu/hr	7.31 Btu/hr	8.21 Btu/hr	7.85 Btu/hr	7.67 Btu/hr	7.31 Btu/hr
	Off (S5)	2.80 Btu/hr	2.65 Btu/hr	3.49 Btu/hr	3.16 Btu/hr	2.87 Btu/hr	2.62 Btu/hr
	Zero Power Mode (ErP)	0.568	Btu/hr	1.043	Btu/hr	0.538	Btu/hr

Example	Processor	1x Intel Xeon	E5-1620 v3 (Qı	uad-Core)					
Configuration #3	Memory	2x 8GB DDR4-	-2133 Register	ed RAM					
	Graphics	1x NVIDIA Quadro K2200							
	Disks/Optical	2x 1TB SATA	2x 1TB SATA 7200 / 1x Slim SuperMulti DVDRW SATA						
	Power Supply	525W 85% Custom PSU							
	Other	N/A							
Energy Consumption		115	VAC	230	VAC	100	VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	51.	41 W	51.1	15 W	52.4	12 W		
	Windows Busy Typ(S0)	179.17 W		175.74 W		176.74 W			
	Windows Busy Max (S0)	201.86 W		198.12 W		196.99 W			
	Sleep (S3)	2.35 W	2.28 W	2.55 W	2.49 W	2.38 W	2.27 W		
	Off (S5)	0.827 W	0.785 W	1.028 W	0.986 W	0.853 W	0.770 W		
	Zero Power Mode (ErP)	0.1	67 W	0.382 W		0.177 W			
		115	5 VAC	230	VAC	100	VAC		
<b>Heat Dissipation</b>		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows Idle (S0)	178.87	2 Btu/hr	174.56	Btu/hr	178.88	Btu/hr		
	Windows Busy Typ(S0)	611.33	3 Btu/hr	599.62	Btu/hr	603.04	Btu/hr		
	Windows Busy Max (S0)	688.7	5 Btu/hr	675.99	Btu/hr	672.13	Btu/hr		
	Sleep (S3)	8.02 Btu/hr	7.79 Btu/hr	8.71 Btu/hr	8.48 Btu/hr	8.13 Btu/hr	7.76 Btu/hr		
	Off (S5)	2.82 Btu/hr	2.67 Btu/hr	3.51 Btu/hr	3.36 Btu/hr	2.91 Btu/hr	2.62 Btu/hr		
	Zero Power Mode (ErP)	0.571	Btu/hr	1.305	Btu/hr	0.604	0.604 Btu/hr		

Example	Processor	1x Intel Xeon	1x Intel Xeon E5-1680 v3 (Eight-Core)				
Configuration #4	Memory	4x 16GB DDR4–2133 Registered RAM					
	Graphics	1x NVIDIA Qua	dro K5200				
Disks / Optical 4x 2TB SATA 7200 / 1x Slir				SuperMulti D\	VDRW SATA		
	Power Supply	700W 90% Custom PSU					
	Other	N/A					
<b>Energy Consumption</b>		115	115 VAC 230 VAC 100 VAC		230 VAC		VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	61.8	8 W	61.39 W		62.35 W	
	Windows Busy Typ(S0)	296.0	54 W	290.88 W		303.03 W	
	Windows Busy Max (S0)	338.0	53 W	334.	85 W	333.11 W	



### **System Technical Specifications**

	Sleep (S3)	3.99 W	3.91 W	4.02 W	4.04 W	3.99 W	3.91 W
	Off (S5)	0.86 W	0.764 W	1.02 W	0.91 W	0.86 W	0.76 W
	Zero Power Mode (ErP)	0.166 W		0.30	)5 W	0.16	55 W
		115	VAC	230	VAC	100	VAC
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	211.16 Btu/hr		209.47 Btu/hr		212.75 Btu/hr	
	Windows Busy Typ(S0)	1012.14 Btu/hr		992.48 Btu/hr		1033.94 Btu/hr	
	Windows Busy Max (S0)	1155.41	Btu/hr	1142.5	1 Btu/hr	1136.57	7 Btu/hr
	Sleep (S3)	13.6 Btu/hr	13.4 Btu/hr	13.7 Btu/hr	13.8 Btu/hr	13.6 Btu/hr	13.4 Btu/hr
	Off (S5)	2.94 Btu/hr	2.60 Btu/hr	3.49 Btu/hr	3.11 Btu/hr	2.91 Btu/hr	2.58 Btu/hr
	Zero Power Mode (ErP)	0.565	Btu/hr	1.042	Btu/hr	0.563	Btu/hr

**NOTE:** Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

### **DECLARED NOISE EMISSIONS**

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration	Processor Info	1x Intel Xeon E5-2650 v3 2.30 GHz		
(Entry level)	Memory Info	2x 8GB DDR4-2133 MHz RDIMM		
	Graphics Info	1x NVIDIA NVS 310		
	Disks/Optical/Floppy	1x 1 TB SATA 7200 RPM		
		1x Blu-ray DVD-RW		

<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.2	14
	Hard drive Operating (random reads)	3.3	15
	DVD-ROM Operating (sequential reads)	4.3	30

System Configuration	Processor Info	1x Intel Xeon E5-1660 v3 3.20 GHz
(High-end)	Memory Info	8x 16GB DDR4-2133 MHz RDIMM
	Graphics Info	1x NVIDIA Quadro K4200
	Disks/Optical/Floppy	2x 600 GB SAS 15K RPM 3.5" HDD 1x Blu-ray DVD-RW

<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
7779 and ISO 9296)	Idle	4.2	26
	Hard drive Operating (random reads)	4.3	27

## **System Technical Specifications**

<b>DVD-ROM Operating</b> (sequential reads)	4.6	31
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### **ENVIRONMENTAL DATA**

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,000 m (10,000 feet) Non-operating: 9,100 m (30,000 feet)
	Dynamic (new)	<b>Shock</b> Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20q
		<b>NOTE:</b> Values represent individual shock events and do not indicate repetitive shock events.
		<b>Vibration</b> Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz <b>NOTE:</b> Values do not indicate continuous vibration.
	Cooling	Above 1524 m (5,000 ft.) altitude, maximum operating temperature is derated by 1° C (1.8° F) per 305 m (1,000 ft.) elevation increase

Physical Security a	nd Serviceability
Access Panel	Tool-less Includes system board and memory information.
Optical Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
<b>Green User Touch Points</b>	Yes, on primary serviceable components.
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD LED on Front of Computer	Yes
<b>Configuration Record SW</b>	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot
Restore CD/DVD Set	Restores the computer to its original factory shipping image; can be obtained via HP Support.



-		
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds	
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 7.0 mm (0.2756 in) diameter padlock loop at rear of system	
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system	
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system	
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed	
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports	
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)	
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation	
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration	
3.3V Aux Power LED on System PCA	Yes	
NIC LEDs (integrated) (Green & Amber)	Yes	
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less	
Power Supply Diagnostic LED	Yes	
Front Power Button	Yes, ACPI multi-function	
Rear Power Button	Yes	
Front Power LED	Yes, white (normal), red (fault)	
Front Hard Drive Activity LED	Yes, white	
Front ODD Activity LED	Yes, on device	
Internal Speaker	Yes	
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.	
Cooling Solutions	Air cooled forced convection heatsinks	
Power Supply Fans	92 mm x 92 mm x 25 mm (non-serviceable)	
CPU Heatsink Fan	92 mm x 25 mm, 6-wire, PWM	
Chassis Fan	Front: (Optional) 92 mm x 92mm x 25 mm, 4-wire, PWM  Rear:	
	92 mm x 92mm x 25 mm, 4-wire, PWM	



## **System Technical Specifications**

Momory Heatsink Fam	Dual 60 mm v 60 mm v 25 mm 6 wire DMM Dlindmate
Memory Heatsink Fan	Dual 60 mm x 60 mm x 25 mm, 6-wire, PWM, Blindmate
HP PC Hardware Diagnostics UEFI	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:
	<ul> <li>Run diagnostics</li> <li>View the hardware configuration of the system</li> </ul>
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision Diagnostics helps provide higher system availability.
	Typical uses of the Vision Diagnostics are:
	<ul> <li>Testing and diagnosing apparent hardware failures</li> <li>Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance</li> <li>Sending configuration information to another location for more in-depth analysis</li> <li>Entered using F2</li> </ul>
Access Panel Key Lock	No
ACPI-Ready Hardware	<ul> <li>Advanced Configuration and Power Management Interface (ACPI).</li> <li>Allows the system to wake from a low-power mode.</li> <li>Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system</li> </ul>
Trusted Platform Module Chip	Infineon TPM 1.2 Certified
Integrated Chassis Handles	Yes, Front handle and dedicated rear recess
Power Supply	Requires T15 Torx or flat blade screwdriver
PCIe Card Retention	Yes, rear (all), middle (all), front (full-length cards with extender, using HP Z4 Fan and Front Card Guide Kit)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes

### **BIOS**



Full BIOS support for PCI Express through industry standard interfaces.  ATAPI Removable Media Device BIOS Specification Version 1.0.  BBS BIOS BOOS Specification v.1.0.1.  WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.  BIOS Boot Spect 1.01+  BIOS Power On Provides more control over how and from what devices the workstation will boot.  BIOS Power On Users can define a specific date and time for the system to power on.  Review and customize system configuration settings controlled by the BIOS.  Recovers system BIOS in corrupted Flash ROM.  Resoluted Setup Settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (FIO Setup).  SWBIOS System Management BIOS 2.7, for system management information.  Boot Control Disables the ability to boot from removable media on supported devices.  Memory Change Alert Thermal Alert Monitors the temperature ranges.  - NORMAL - normal temperature ranges.  - ALERTED - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALERTED - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALERTED - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALERTED - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIOWS the system to enter and resume from low power modes (sleep states).  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  ALIOWS the system to enter and resume from low power on s			
ATAPI ATAPI Removable Media Device BIOS Specification Version 1.0.  BIOS Boot Specification v1.01.  WMI Support  WMI is Mirosport's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.  BIOS Power On  BIOS Power On  Users can define a specific date and time for the system to power on.  Review and customize system configuration settings controlled by the BIOS.  System/Emergency ROM  Recovers system BIOS in corrupted Flash ROM.  Respicated Setup  Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Disables the ability to boot from removable media on supported devices.  Memory Change Alert  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  ALERTEO - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOMY - excessive temperatures are reducted. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOMY - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOMY - excessive temperatures are reduced.  ACPI (Advanced  ACPI (Advanced  Allows the system to enter and resume from low power modes (steep states).  Configuration and Power  Management Interface)  Allows the system to enter and resume from low power modes (steep states).  Configuration and Power bardware component damage occurs.  Provides secure, fall-safe ROM image management from a central network console.  Allows the relief string stored in non-volatile memory that is displayed in the BlOS splash screen	BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4	
MWI Support WIM is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows, WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.  BIOS Boot Spec 1.01+ BIOS Boot Spec 1.01+ BIOS Power On Users can define a specific date and time for the system to power on.  Review and customize system configuration settings controlled by the BIOS.  Seystem/Emergency ROM Resh Recovery with video Replicated Setup Replicated Setup Replicated Setup Replicated Setup System Management BIOS 2.7, for system management information.  System Management BIOS 2.7, for system management information.  Disables the ability to boot from removable media on supported devices.  Memory Change Alert Thermal Alert Monitors the temperature state within the chassis. Three modes: NORMAL – normal temperature ranges. ALERTED – excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN – excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACP! (Advanced Configuration and Power Management Interface)  Remote ROM Flash ACP! (Advanced Configuration and Power Management Interface)  Remote System Subject on the dynamic workload.  Allows the system to enter and resume from low power modes (sleep states).  Configuration and Power Management Interface (Shutdown Interface)  Remote System Interface Shutdown  Makes it possible to place individual cards and peripherals in a low-power or powered—off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Allows to revision tevels  Allows a new or existing system to boot over the network and download software, including the instantly Available PC (Suspend to RAM - ACPI)  Allows a new or existing system to control system power consumption based on the dynamic workload.	PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
Will is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows, Will is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.  BIOS Power On  ROM Based Computer Setup Utility (F10)  System/Emergency ROM Rash Recovery with Video  Recovers system BIOS in corrupted Flash ROM.  Replicated Setup  Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Bioso Control  Disables the ability to boot from removable media on supported devices.  Alerts management console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  *NORMAL - normal temperature ranges.  *ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  *SHUTDOWN - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  *SHUTDOWN - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  *Provides secure, fail-safe ROM image management from a central network console.  ALIPITOWN - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  *Provides secure, fail-safe ROM image management from a central network console.  Allows the system to enter and resume from low power modes (sleep states).  For the substitution of the system of the system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other lenners of the system.  System bade for Park - Reports the system BIOS revisi	ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.	
fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM Specifications.  Provides more control over how and from what devices the workstation will boot.  BIOS Power On  Review and customize system configuration settings controlled by the BIOS.  Review and customize system configuration settings controlled by the BIOS.  System/Emergency ROM  Recovers system BIOS in corrupted Flash ROM.  Resplicated Setup  Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Disables the ability to boot from removable media on supported devices.  Alerts management console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  * ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  * SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without warning before hardware component damage occurs.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  Remote Wakeup/Remote Shutdown  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without file of the system of the provide of the provides secure, fall-safe ROM image management from a central network console.  Reflect and the provide of the provide of t	BBS	BIOS Boot Specification v1.01.	
Users can define a specific date and time for the system to power on.	WMI Support		
Review and customize system configuration settings controlled by the BIOS.  Recovers with villeo  Recovers system BIOS in corrupted Flash ROM.  Replicated Setup  Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Disables the ability to boot from removable media on supported devices.  Alerts management console if memory is removed or changed.  Thermal Alert  Alerts management console if memory is removed or changed.  Thermal Alert  Nomitors the temperature ranges.  • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage cours.  Remote ROM Flash  ACPI (Advanced Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Allows the system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system power consumption based on the BIOS splash screen.  System daministrators can power on, restart, and power off a client computer from a remote location. System damini	BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	
Sexup Utility (F10) System/Emergency ROM Replicated Setup Replicated Setup Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Boot Control Disables the ability to boot from removable media on supported devices.  Memory Change Alert Thermal Alert  Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Makes it possible to place individual cards and peripherats in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag Remote Wakeup/Remote Shutdown Allows for very low power consumption with quick resume from a remote location. Shutdown Instantly Available PC (Suspend to RAM - ACP) sleep state 53.  Allows for very low power consumption with quick resume time.  System administrators can power on, restart, and power off a client computer from a remote location. Shutdown Instantly Available PC (Suspend to RAM - ACP) Sleep state 53.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  System Board revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications	BIOS Power On	Users can define a specific date and time for the system to power on.	
Flash Recovery with Video Replicated Setup Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS System Management BIOS 2.7, for system management information. Disables the ability to boot from removable media on supported devices.  Memory Change Alert Thermal Alert Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Allows the system to enter and resume from low power modes (sleep states). Canables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag Remote Wakeup/Remote Shutdown Instantly Available PC (Suspend to RAM - ACPI sleep state 53) Remote Boot from Server)  Allows for very low power consumption with quick resume time.  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system in industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision levels  Assesses sy	ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.	
replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7, for system management information.  Disables the ability to boot from removable media on supported devices.  Alerts management console if memory is removed or changed.  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Provides secure, fail-safe ROM image management from a central network console.  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  Remote Wakeup/Remote Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep states 53)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  Allows for very low power consumption with quick resume time.  System administrators can power on, restart, and power off a client computer from a remote location. Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep states 53)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an ewo revision	System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Boot Control  Disables the ability to boot from removable media on supported devices.  Memory Change Alert  Alerts management console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload.  Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  Remote Wakeup/Remote  Shutdown  Allows for very low power consumption with 44-bit operating systems.  Allows for very low power consumption with quick resume time.  System administrators can power on, restart, and power off a client computer from a remote location. Shutdown  Instantly Available PC  (Suspend to RAM - ACPI sleep State S3)  Remote System  Installation via F12 (PXE 2.1) (Remote Boot from server)  Remote System  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an new or existing system to boot over the network and download software, including the operating system.  Allows an new or existing system to boot over the network and download software, including the operating system.  Allows an new or existing system to computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that	Replicated Setup	replicate these settings on machines being deployed without entering Computer Configuration Utility	
Alerts management console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location. Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend t	SMBIOS	System Management BIOS 2.7, for system management information.	
Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location. Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  PROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.	Boot Control	Disables the ability to boot from removable media on supported devices.	
• NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Provides secure, fail-safe ROM image management from a central network console.  ACPI (Advanced Configuration and Power Management Interface)  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  Remote Wakeup/Remote Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep state 53)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.	Memory Change Alert	Alerts management console if memory is removed or changed.	
ACPI (Advanced Configuration and Power Management Interface) Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  System to an every low power consumption with quick resume time.  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Remote Boot from Server)  Rom revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.	Thermal Alert	<ul> <li>NORMAL - normal temperature ranges.</li> <li>ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer</li> </ul>	
Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  System administrators can power on, restart, and power off a client computer from a remote location.  Allows for very low power consumption with quick resume time.  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an ew or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an an export this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.	Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.	
System administrators can power on, restart, and power off a client computer from a remote location.	ACPI (Advanced Configuration and Power Management Interface)	Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.	
Allows for very low power consumption with quick resume time.  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.  (Power-on Self-Test)	Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.	
(Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.	Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.	
operating system.  Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision   Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Operating system.	Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.	
available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Assesses system health at boot time with selectable levels of testing.	Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)		
Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Revision level is digitally encoded into the HW and cannot be modified.	ROM revision levels	available through an industry standard interface (SMBIOS) so that management SW applications can	
(Power-on Self-Test)	System board revision level	Revision level is digitally encoded into the HW and cannot be modified.	
Auto Setup when new System automatically detects addition of new hardware.	Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.	
	Auto Setup when new	System automatically detects addition of new hardware.	



### **System Technical Specifications**

hardware installed	
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
UEFI Specification Revision	2.3.1
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
ТРМ	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification
	Universal Serial Bus Revision 2.0 Specification
	Universal Serial Bus Revision 3.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.7
	External BIOS simulator found at: <a href="http://h20464.www2.hp.com/index.html">http://h20464.www2.hp.com/index.html</a>

## Social and Environmental Responsibility

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:	
<ul> <li>ENERGY STAR® (energy-saving features available on selected configurations-Windows only)</li> <li>US Federal Energy Management Program (FEMP)</li> </ul>	



System reclinical Sp	
	<ul> <li>China Energy Conservation Program</li> <li>The ECO declaration (TED)</li> </ul>
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal  The battery in this product does not contain:   Mercury greater than 5ppm by weight
	<ul> <li>Cadmium greater than 10ppm by weight</li> <li>Lead greater than 40ppm by weight</li> </ul>
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. <a href="http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf">http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf</a> Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide
Low Halogen Statement	basis. This product is low-halogen except for power cords, external cables and peripherals. The following customer-configurable internal components may not be low-halogen: 3 ½" SAS HDDs and LSI 9217-4i4e SAS ROC RAID Card. Service parts obtained after purchase may not be low-halogen.
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/recycle">http://www.hp.com/recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report <a href="http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html">http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html</a> Eco-label certifications <a href="http://www.hp.com/hpinfo/qlobalcitizenship/environment/productdesign/ecolabels.html">http://www.hp.com/hpinfo/qlobalcitizenship/environment/productdesign/ecolabels.html</a> ISO 14001 certificates:
Additional Information	<ul> <li>http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> <li>http://www.hp.com/hpinfo/globalcitizenship/environment/productdata/disassemblyworkstatio.html</li> <li>Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.</li> <li>EPEAT Gold - ENERGY STAR qualified configurations of this product are in compliance with the IEEE 1680 (EPEAT) standard at the Gold level where HP registers workstation products. See <a href="http://ww2.epeat.net/CompanyDetail.aspx?CompanyID=24">http://ww2.epeat.net/CompanyDetail.aspx?CompanyID=24</a> for registration status in your country.</li> </ul>
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html">http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html</a> • Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment  • Does not contain ozone-depleting substances (ODS)  • Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed



	<ul> <li>Maximizes the use of post-consumer recycled content materials in packaging materials</li> <li>All packaging material is recyclable</li> <li>All packaging material is designed for ease of disassembly</li> <li>Reduced size and weight of packages to improve transportation fuel efficiency</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting</li> </ul>		
Packaging Materials			
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).		
External	Outer carton, accessories carton, and insert made of corrugated paper board.		

Manageability			
Industry Standard Specifications	This product meets the following industry standard specifications for manageability functionality:		
	DASH 1.1 (via Intel® LAN on motherboard)		
ntel Active Management Fechnology (AMT)	Intel® Active Management Technology (AMT) 9.1		
	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.1 includes the following advanced management functions:  Power Management (on, off, reset, graceful shutdown, sleep and hibernate)  Support in Max Power Savings (Shutdown and Hibernate Modes)  Hardware Inventory (includes BIOS and firmware revisions)  Hardware Alerting  Agent Presence  System Defense Filters  Serial Over LAN (SOL)  IDE Redirect  ME Wake-on-LAN (WOL)  DASH 1.1 compliance  IPv6 Support  Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection  Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance.  Remote Alerts - automatically alert IT or service provider if issues arise  Access Monitor - Provides oversight into Intel® AMT actions to support security requirements  PC Alarm Clock  Microsoft NAP Support  Host Base set-up and configuration  Management Engine (ME) firmware roll back  Local Time Sync to UTC  Remote Memory Dump Command - Creates memory dump for debug		
ntel® vPro™ Technology	The HP Z440 Workstation supports Intel® vPro technology when configured as outlined below:		
	<ul> <li>Intel® Xeon processor E5-1600 v3 or E5-2600 v3 product family featuring Intel® vPro Technology</li> <li>Intel® C612 chipset</li> </ul>		



	Intel® I218LM GbE LAN			
Remote Manageability Software Solutions	The HP Z440 Workstation is supported on the following remote manageability software consoles:  • LANDesk Management Suite (HP recommended solution)			
	<ul> <li>Microsoft System Center Configuration Manager</li> <li>HP Client Automation Enterprise</li> </ul>			
	For questions or support for manageability needs, please visit <a href="http://www.hp.com/qo/easydeploy">http://www.hp.com/qo/easydeploy</a>			
System Software Manager	For questions or support for SSM, please visit: <a href="http://www.hp.com/go/ssm">http://www.hp.com/go/ssm</a>			
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.			
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.  NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.  NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.			
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <a href="http://www.hp.com/qo/lookuptool">http://www.hp.com/qo/lookuptool</a> . Additional HP Care Pack Services information by product is available at: <a href="http://www.hp.com/hps/carepack">http://www.hp.com/hps/carepack</a> . Service levels and response times for HP Care Packs may vary depending on your geographic location.			
Product Change Notification	<ul> <li>Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.</li> <li>PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.</li> <li>Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.</li> </ul>			



#### **Stable & Consistent Offerings**

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
	J6S68AV	Intel Xeon E5-1620 v3 3.5GHz 4-core 10MB 2133
	J6S71AV	Intel Xeon E5-2630 v3 2.4GHz 8-core 20MB 1866
Hard Drives	Product #	Offering
	J3H77AV	500GB 7200 RPM SATA 1st Hard Disk Drive
	J3H98AV	500GB 7200 RPM SATA 2nd Hard Disk Drive
	J3J19AV	500GB 7200 RPM SATA 3rd Hard Disk Drive
	J3J39AV	500GB 7200 RPM SATA 4th Hard Disk Drive
	J3H78AV	1TB 7200 RPM SATA 1st Hard Disk Drive
	J3H99AV	1TB 7200 RPM SATA 2nd Hard Disk Drive
	J3J20AV	1TB 7200 RPM SATA 3rd Hard Disk Drive
	J3J40AV	1TB 7200 RPM SATA 4th Hard Disk Drive
Graphics	Product #	Offering
	J1P69AV	NVIDIA NVS 510 2GB 1st Graphics
	J1P81AV	NVIDIA NVS 510 2GB 2nd Graphics
	J1P71AV	NVIDIA Quadro K620 2GB 1st Graphics
	J1P83AV	NVIDIA Quadro K620 2GB 2nd Graphics
	J1P72AV	NVIDIA Quadro K2200 4GB 1st Graphics
	J1P84AV	NVIDIA Quadro K2200 4GB 2nd Graphics
	J1P76AV	AMD FirePro W2100 2GB 1st Graphics
	J1P85AV	AMD FirePro W2100 2GB 2nd Graphics
Memory	Product #	Offering
	G8U28AV	8GB DDR4-2133 (1x8GB) Registered RAM
	G8U32AV	16GB DDR4-2133 (2x8GB) Registered RAM
	G8U34AV	32GB DDR4-2133 (4x8GB) Registered RAM
	G8U36AV	64GB DDR4-2133 (8x8GB) Registered RAM

G8U35AV

G8U37AV

G8U38AV

32GB DDR4-2133 (2x16GB) Registered RAM

64GB DDR4-2133 (4x16GB) Registered RAM

128GB DDR4-2133 (8x16GB) Registered RAM

### **Stable & Consistent Offerings**

<b>Optical and Removable</b>
Storage

**Product #** F5W18AV G8U22AV

#### Offering

Slim SuperMulti DVDRW SATA 1st Optical Disk Drive Slim SuperMulti DVDRW SATA 2nd Optical Disk Drive



#### STORAGE/HARD DRIVES

**HP SAS (Serial Attached** SCSI) Hard Drives for HP Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity 600GB Height 1 in: 2.54 cm Width **Media Diameter** 

3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS **Synchronous Transfer** 6.0 Gb/s Rate (Maximum)

**Buffer** 16 MB

**Seek Time** (typical reads, Single Track 0.2 ms includes controller **Average** 3.4 ms overhead, including **Full Stroke** 6.6 ms

settling)

**Rotational Speed** 15,000 rpm

**Logical Blocks** 1,172,123,568 - 512 byte blocks 50° to 95° F (10° to 35° C)

**Operating Temperature** 

300GB SAS 15K rpm 6Gb/s 3.5" HDD

300GB Capacity Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS **Synchronous Transfer** 6Gb/s Rate (Maximum)

**Buffer 16MB** 

**Seek Time** (typical reads, **Single Track** 0.2 ms includes controller Average 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

**Rotational Speed** 15,000 rpm

50° to 95° F (10° to 35° C) **Operating Temperature** 

**HP 300GB SAS 10K SFF HDD** 

Capacity 300GB Height 0.6 in: 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Up to 600MB/s

SAS 6Gb/s

Interface **Synchronous Transfer** 

Rate (Maximum)

**Buffer 64MB** 

Cache multi-segmentable cache buffer Seek Time (typical reads, **Single Track** 0.4 ms (max) includes controller Average 3.6 ms overhead, including **Full Stroke** 7.3 ms

settling)

**Rotational Speed** 10,000 rpm **Logical Blocks** 585,937,500

**Operating Temperature** 41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF

HDD

Capacity 600GB

**Height** 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

InterfaceSAS 6Gb/sSynchronous TransferUp to 600MB/s

Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controller overhead, including settling)Single Track o.4 ms (max)Average study3.6 msFull Stroke7.3 ms

Rotational Speed 10,000 rpm Logical Blocks 1,172,123,568

**Operating Temperature** 41° to 131° F (5° to 55° C)

HP 1.2TB SAS 10K SFF HDD Capacity 1.2TB

**Height** 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical<br/>reads, includes<br/>controller overhead,<br/>including settling)Single Track<br/>Average<br/>Full Stroke0.18ms (max)<br/>3.5ms<br/>7.17ms

Rotational Speed 10,000 rpm Logical Blocks 2,344,225,968

**Operating Temperature** 41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard Drives for HP Workstations 500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 500GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in: 10.17 cm

Up to 600MB/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

**Buffer** 

16MB

Seek Time (typical reads, Single Track 2 ms

includes controller overhead, including	Average Full Stroke	11 ms 21 ms
settling)		
<b>Rotational Speed</b>	7,200 rpm	
Logical Blocks	976,773,168	

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Up to 600 MB/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

**Synchronous Transfer** Rate (Maximum)

**Buffer** 64MB Cache Adaptive

**Seek Time** (typical reads, **Single Track** 2 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 21 ms settling)

**Rotational Speed** 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2.0TB Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600 MB/s Rate (Maximum)

**Buffer** 64MB

**Seek Time** (typical reads, **Single Track** 1.0 ms includes controller Average 11 ms overhead, including **Full Stroke** 18 ms settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 3,907,029,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 3.0TB Height 1 in; 2.54 cm

> **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4.0 in; 10.17 cm

Serial ATA (6.0Gb/s), NCQ enabled Interface

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)

Width

Buffer 64MB

Seek Time (typical reads, Single Track 0.6 ms

includes controller overhead, including

settling)

**Average Full Stroke** 

11 ms **Not Specified** 

**Rotational Speed** 7.200 rpm

**Operating Temperature** 41° to 140° F (5° to 60° C)

**HP Solid State Drives** (SSDs) for Workstations HP 128GB SATA 6Gb/s

SSD

Capacity 128GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s

**Synchronous Transfer** Rate (Maximum)

**Operating Temperature** 

Up to 500MB/s (Sequential Read)

32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s

SSD

256GB Capacity

Height 0.28 in; 0.7 cm Interface SATA 6Gb/s

**Synchronous Transfer** 

Rate (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s

**SED SSD** 

Capacity 256GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

**Synchronous Transfer** 

Rate (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s

SSD

Capacity 512GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

**Synchronous Transfer** 

Rate (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

**HP 1TB SATA 6Gb/s SSD** Capacity 1TB

> Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

**Synchronous Transfer** 

Rate (Maximum)

Up to 550MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

PCIe SSDs for HP Workstations

### **Technical Specifications - Hard Drives**

Samsung Enterprise 240GB SATA SSD	Capacity Width Interface Synchronous Transfer Rate (Maximum)	240GB <b>Physical Size</b> SATA 6Gb/s  600 Mb/s	2.5 in; 6.36 cm
Samsung Enterprise	Capacity	480GB	
480GB SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	600 Mb/s	
Intel Pro 1500 180GB	Capacity	180GB	
SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	600 Mb/s	
	Operating Temperature	32° to 158° F (0° to 70°	C)
HP Z Turbo Drive 256GB	Capacity	256GB	
SSD	Interface	PCI Express 2.0 x4 electrical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° C)	
HP Z Turbo Drive 512GB	Capacity	512GB	
SSD	Interface	PCI Express 2.0 x4 electrical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70°	, C)



## **Technical Specifications - Hard Drive Controllers**

### HARD DRIVE CONTROLLERS

LSI 9217-4i4e 8-port SAS PCI Bus 8 lanes, PCI Express 3.0

6Gb/s RAID Card RAID Levels

**RAID Levels** Offers Integrated RAID (0, 1, 1E and 10)

PCI Data Burst Transfer Half Duplex x8, PCIe, 8000 MB/s

Rate

SAS Bandwidth Half Duplex 600 MB/s per lane

PCI Card Type 3.3V Add-in Card PCI Voltage 12 V ± 10%

**PCI Power** 9.8W typical, Airflow min 200 LFM

BracketFull height and low profileCertification LevelPCI Express 3.0 compliantSAS ProcessorLSI SAS2308/ Fusion MPT 2.0

Internal ConnectorsOne x4 internal mini-SAS (SFF8087)External ConnectorsOne x4 external mini-SAS (SFF8088)Maximum Number of SCSI256 Non-RAID SAS/SATA devices

**Devices** 

**LED Indicators** N/A

### **GRAPHICS**

**NVIDIA NVS 310 512MB** 

**Graphics** 

Form Factor Low Profile:

2.7 inches (H) x 5.7 inches (L), Half-Height

Weight: ~142 grams

**Graphics Controller** NVIDIA NVS 310

GPU: GF119-825

**Bus Type** PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

**Connectors** 2 x DisplayPort

**Maximum Resolution** Up to 2560 x 1600 (digital display) per display.

**Image Quality Features** 

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support

- Support for 3D Blu Ray

VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

**Display Output** 

Up to 2 displays in the following configurations:

### DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

#### **DVI-D** output:

Drives two digital display at resolutions up to 1920 × 1200 at 60
Hz with reduced blanking using DisplayPort to DVI-D single-link
cable adaptors



Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

### **HDMI** output:

NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

### VGA display output:

Drives two analog display at resolutions up to 1920 x 1200 at 60 Hz using DisplayPort to VGA cable adaptors

**Shading Architecture** 

Shader Model 5.0 Supported Graphics APIs DX11, OpenGL 4.1

**Available Graphics Drivers** 

Windows 8

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or <a href="http://www.nvidia.com">http://www.nvidia.com</a>

**Notes** 

- 1. The thermal solution used on this card is an active fan heatsink.
- 2. Factory configured NVS 310 graphics card have no cable adapters included. Adapters must be ordered separately.
- 3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

### **NVIDIA NVS 315 1 GB Graphics**

Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Weight: ~142 grams

**Graphics Controller** NVIDIA NVS 315 (using GF119-825 GPU)

Number of Cores: 48 CUDA cores

Max. Power: 19.3W

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express x16, 2.0 compliant

Memory Size: 1GB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

**Connectors** DMS-59 output

#### Cables included:

- For CTO: DMS-59 to DVI cable

- For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable

#### **Maximum Resolution**

Maximum number of displays supported: 2

### **Maximum Resolution Support:**

- DMS-59 to VGA: 2048 x 1536 @ 85Hz - DMS-59 to DVI: 1980 x 1200 @ 60Hz - DMS-59 to DP: 2560 x 1600 @ 60Hz

### **Image Quality Features**

See Display Output section.

The following video formats are supported:

- MPEG2
- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support- Support for 3D Blu Ray
- VC1
- DivX version 3.11 or later

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

### **Display Output**

Up to 2 displays using one of the following DMS-59 cables:

- DMS-59 to DVI
- DMS-59 to VGA
- DMS-59 to DP

### DisplayPort output:

 Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.

### **DVI-D** output:

Drives two digital display at resolutions up to 1920 × 1200 at 60
Hz with reduced blanking using DMS-59 to DVI-D single-link cable
adaptor

### VGA display output:

• Drives two analog displays at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.

### **Shading Architecture**

Shader Model 5.0



Supported Graphics APIs DX11, OpenGL 4.3

Available Graphics

Windows 8

Drivers

Microsoft Windows 7 Professional (64-bit and 32-bit)
Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/

**Notes** 

1. The thermal solution used on this card is an active fan heatsink.

2. Factory configured NVS 310 graphics card have no cable adapters

included. Adapters must be ordered separately.

3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA

cables (one each).

NVIDIA NVS 510 2GB Graphics Form Factor

Low Profile, 2.713 inches × 6.3 inches, single slot

**Graphics Controller** 

NVS 510 GPU Core Clock: 797 MHz Memory Clock: 891 MHz

CUDA Cores: 192

**Bus Type** PCI Express x16, Generation 2.0

Memory 2GB DDR3

**Connectors** Four mini-DisplayPort.

Four mini-DisplayPort-to-DisplayPort adapters included.

(DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories) Mini-DisplayPort connectors support ultra-high-resolution panels (up to

2040 v 2160 @

3840 x 2160 @ 60Hz)

Note: This card supports up to four displays. For Windows XP, only 2 active displays are supported.

**Image Quality Features** 

**Maximum Resolution** 

10-bit internal display processing, including hardware support for 10-bit

scan-out

**Display Output** 

DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2

(HBR2) support.

### **Digital Display Support**

### **DisplayPort Output**

 Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.



DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology – up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

### **DVI-D Output**

- Drives four digital displays at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.
- Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.

### **HDMI Output**

The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.

### **Analog Display Support**

### VGA display output

Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors.

Supported Graphics APIs Full Microsoft DirectX 11, Shader Model 5.0 support Full OpenGL 4.3 support

**Available Graphics Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Notes** Heatsink cooler design is active.

NVIDIA Quadro K620 2GB Form Factor

**Graphics** 

2.713" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

Weight: 133 grams

**Graphics Controller NVIDIA Quadro K620 Graphics Card** 

> GM107 GPU 384 CUDA cores Max Power: 45 Watts

**Bus Type** PCI Express 2.0 x16 Memory 2 GB GDDR3, 900 MHz

> 128-bit memory I/O path 29 GB/s memory bandwidth

## Technical Specifications - Graphics

**Connectors** 1 DL-DVI(I) output, 1 DisplayPort output

Factory Configured: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as Factory Configuration or Option Kit accessories.

Maximum Resolution DisplayPort 1.2:

- up to 4096x2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Dual Link DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

**Display Output** 1 Dual-link DVI-I connector

1 Display Port connector

Shading Architecture

Full Microsoft DirectX 11.1 Shader Model 5.0

Supported Graphics APIs

OpenGL 4.4 DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

**Available Graphics** 

**Drivers** 

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Notes** 

1. Factory configured Quadro K620 does not include a video cable adapter. Video cable adapters must be ordered separately.

Quadro K620 offered as an Option Kit (AMO) includes one DP-to-DVI video cable adapter. Additional cables must be ordered

separately.

NVIDIA Quadro K420 1GB Form Factor Graphics

Form Factor Low Profile:

2.713 inches × 6.3 inches, single slot

Graphics Controller NVIDIA Quadro K420

GPU: GK107

**Bus Type** PCI Express x16, 2.0 compliant

Memory Size: 1GB DDR3 Clock: 891MHz

Memory Bandwidth: 29GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

**Maximum Resolution** VGA (via adapter cable):

2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

• 3840 × 2160 × 30 bpp at 60 Hz

RAMDAC 400 MHz integrated RAMDAC

**Display Output** Maximum number of displays supported: 2

Shading Architecture Shader Model 5.0 Supported Graphics APIs DX11, OpenGL 4.4

Programming support for CUDA C, CUDA C++, DirectCompute 5.0, OpenCL,

Python, and Fortran

**Available Graphics** 

**Drivers** 

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

Notes 1. Factory configured Quadro K420 does not include any video

adapters. Adapters must be ordered separately.

2. Option kit Quadro K420 includes one DP to DVI-D adapter.

NVIDIA Quadro K2200 4 GB Graphics **Form Factor** 4.38" H x 7.97" L

Single Slot, Full Height

Weight: 240 grams

Graphics Controller NVIDIA Quadro K2200 Graphics Card

GM107 GPU 640 CUDA cores Max Power: 67.7 Watts PCI Express 2.0 x16

Bus Type PCI Express 2.0 x16

Memory 4 GB GDDR5, 2500 Mhz
128-bit memory I/O path
80 GB/s memory bandwidth

**Connectors** 1 DL-DVI(I) output, 2 DisplayPort outputs

Factory Configured Option: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

**Maximum Resolution** DisplayPort:

- up to 4096 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

**Display Output** VGA:

requires use of DVI-to-VGA and/or DP-to-VGA video cable

adapters



- 400 MHz integrated RAMDAC
- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

#### DL-DVI(I):

Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

### SL-DVI(I):

Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

### DisplayPort:

- Supports HBR2 and MST
- Max resolution: 4096 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K2200 DisplayPort connector at this resolution)
- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K2200 DisplayPort connector: 4 with maximum resolution of 1920 x 1200

Maximum number of monitors across all available Quadro K2200 outputs is 4

## Shading Architecture Supported Graphics APIs

Full Microsoft DirectX 11.1 Shader Model 5.0

OpenGL 4.4 DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

#### **Notes**

- Quadro K2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
- Quadro K2200 offered as an Option Kit includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays or a DisplayPort 1.2 hub device.
- 4. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K2200 DisplayPort output.

## AMD FirePro W2100 2GB Graphics

Form Factor

Low Profile, half length (full-height bracket included)

**Graphics Controller** 

AMD FirePro™ W2100 professional graphics

Power: <50W Cooling: Active



## Technical Specifications - Graphics

**Bus Type** PCI Express® x8, Generation 3.0

Memory 2GB DDR3 memory

Memory Bandwidth: 14.4 GB/s

**Connectors** 2x Display Port 1.2 connectors

Factory Configured: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

**Maximum Resolution** DisplayPort 1.2:

up to 4096x2160 x 30 bpp @ 60Hz

Dual Link DVI(I) (requires adapter cable):

up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I)(requires adapter):

up to 1920 x 1200 x 32 bpp @ 60Hz

VGA(requires adapter):

up to 1920 x 1200 x 32 bpp @ 60Hz

**Display Output** 2 x DisplayPort® 1.2

**Shading Architecture** Shader Model 5.0

Supported Graphics APIs OpenCL™ 1.2, DirectX® 11 and OpenGL 4.4

Available Graphics Drivers

Windows 8.1 (64-bit and 32-bit)
Windows 7 (64-bit and 32-bit)
Red Hat Enterprise Linux (RHEL)

SUSE Linux Enterprise Desktop 11(64-bit and 32-bit)

Ubuntu

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Notes** Depending on the card model, native DisplayPort™ connectors and/or

certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details

## **Technical Specifications - Graphics**

NVIDIA Quadro K4200 4GB Graphics **Form Factor** 4.376" H x 9.5" L

Single Slot, Full Height

Weight: ~458 grams (without extender)

Graphics Controller NVIDIA Quadro K4200 Graphics Card

Kepler GK104 GPU 1344 CUDA cores

Max Power: 108 Watts

**Bus Type** PCI Express 2.0 x16

Memory 4 GB GDDR5, 2700 MHz

256-bit memory I/O path

173 GB/s memory bandwidth

CTO: No video cable adapter included

1 DL-DVI(I) output, 2 DisplayPort outputs

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

**Maximum Resolution** DisplayPort:

Connectors

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

**Image Quality Features** 

10-bit internal display processing pipeline

10-bit scan-out support

**Display Output** VGA:

requires use of DVI-to-VGA and/or DP-to-VGA video cable

adapters

400 MHz integrated RAMDAC

• Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz



### DisplayPort:

- Supports HBR2 and MST
- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4200 DisplayPort connector at this resolution)
- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4200 DisplayPort connector: 4 with maximum resolution of 1920 x 1200

#### HDMI:

- Requires use of DP-to-HDMI cable
- Max Resolution: 1920 x 1080 x 32 bpp @ 60Hz

Maximum number of monitors across all available Quadro K4200 outputs is 4.

**Shading Architecture** 

Full Microsoft DirectX 11 Shader Model 5.0

Supported Graphics APIs OpenGL 4.4

DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

**Available Graphics Drivers** 

Microsoft Windows 8.1 Microsoft Windows 8

Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

#### Notes

- Quadro K4200 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- Ouadro K4200 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays or a DisplayPort 1.2 hub device.
- A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4200 DisplayPort output.

## **Technical Specifications - Graphics**

NVIDIA Quadro K5200 8GB Graphics **Form Factor** 4.376" H x 10.5" L

**Dual Slot** 

Weight: ~880 grams

Graphics Controller NVIDIA Quadro K5200

**GK 110 GPU** 

2304 CUDA cores

Max Power: 150 Watts

**Bus Type** PCI Express 3.0 x16

Memory 8GB GDDR5

256-bit memory I/O path192 GB/s memory bandwidth

**Connectors** DVI-I (1), DVI-D (1), DP (2),

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to

Dual-Link DVI adapters available as accessories.

**Image Quality Features** 

 DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support

NVIDIA 3D Vision™ technology

**Display Output** 

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 ×

1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):
 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.



## **Technical Specifications - Graphics**

Maximum resolution: 4096 × 2160 × 30 bpp at 60Hz

Maximum resolution:2560 x 1600 x 30bpp at 120Hz

**HDMI** 

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

**Shading Architecture** Shader Model 5.0

Supported Graphics APIs OpenGL 4.4

DirectX 11

API support for NVIDIA's CUDA ™ C, CUDA C++, DirectCompute 5.0,

OpenCL, Java, Python, and Fortran

**Available Graphics Drivers** Windows 8

Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 SP3(64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Notes** 

 NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K5200 to enable direct mapping of GPU to Virtual Machine.

2. No display output adapter included.

NVIDIA Quadro K6000 12GB Graphics **Form Factor** 4.376" H x 10.5" L

**Dual Slot** 

Power: 234 Watts

Weight: ~880 grams

**Graphics Controller** NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz

**Bus Type** PCI Express 3.0 x16

## **Technical Specifications - Graphics**

Memory 12GB GDDR5

> 384-bit memory I/O path 288 GB/s memory bandwidth

**ECC Memory** 

**Connectors** DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to

Dual-Link DVI adapters available as accessories.

**Image Quality Features** 

• DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2

(HBR2), HDMI 1.4, and HDCP support

NVIDIA 3D Vision™ technology

NVIDIA Premium Mosaic and nView

**Display Output** 

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 ×

32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI

mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

**HDMI** 

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

**Shading Architecture** Shader Model 5.0

Full IEEE 764-2008 32-bit and 64-bit precision

**Supported Graphics APIs** Full OpenGL 4.3



Full DirectX 11

**CUDA API support includes:** 

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

### **Available Graphics Drivers** Windows 8

Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or <a href="http://www.nvidia.com">http://www.nvidia.com</a>

Notes

- NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000 to enable direct mapping of GPU to Virtual Machine.
- 2. No display output adapter included.

### HIGH PERFORMANCE GPU COMPUTING

NVIDIA Tesla K40 Workstation Compute Processor Form Factor Size: 4.376 inches by 10.5 inches

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~826 grams

**System Interface** PCI Express Gen3 ×16

Video Outputs None.

Memory 12GB GDDR5,

memory path: 384-bit memory clock: 3Ghz

Peak Memory Bandwidth 288 GB/s

**Supported APIs** CUDA, OpenACC, OpenCL 1.2 API support includes:

C, C++, Java, Python, and Fortran

**Supported Operating** 

**Systems** 

Windows 8 (64-bit)

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:



**Technical Specifications - Graphics** 

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

**Processor Cores** GK110B GPU

Base Clock: 745 MHz

Boost Clock: up to 875 MHz

2888 CUDA cores

Power Consumption ~235 Watts

**Note:** A 700W PSU is required for any K40 configuration on the Z440.



### OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim SuperMulti DVD Writer **Description** 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions (WxHxD)** 128 x 9.5 x 127mm

Supported Media Types DVD-RAM DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

**Disc Capacity** DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 200 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

**Rates** 

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD-RAM Up to 8X

DVD+RW Up to 8X
DVD-RW Up to 8X
DVD+R DL Up to 8X
DVD-R DL Up to 8X
DVD-ROM Up to 8X
DVD-ROM DL Up to 8X
DVD-ROM DL Up to 8X
DVD+R Up to 8X
DVD-R Up to 8X

Power Source SATA DC power receptacle

DC Power Requirements  $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$  DC Current 5 VDC -< 800 mA typical, < 1600 mA

maximum

**Operating Environmental** Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing) Relative

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Operating Systems
Supported

Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

and 64-bit.

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or Windows XP

Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

## Technical Specifications — Optical and Removable Storage

**Kit Contents** 9.5mm Slim SuperMulti DVD Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

HP 9.5mm Slim DVD-ROM Description Drive

**Mounting Orientation** 

9.5mm height, tray-load

**Interface Type** 

Either horizontal or vertical

Dimensions (WxHxD)

128 x 9.5 x 127mm

SATA / ATAPI

**Disc Capacity** 

DVD-ROM Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

< 110 ms (typical)

**Access Times DVD-ROM Single Layer** 

CD-ROM Mode 1 < 110 ms (typical) Full Stroke DVD < 230 ms (typical) Full Stroke CD < 220 ms (typical)

**Power** Source SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p

**DC Power Requirements DC Current** 

5 VDC - <800mA typical, < 1600 mA

maximum

**Operating Environmental** Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature

84° F (29° C)

**Operating Systems** Supported

Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

and 64-bit.

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or Windows XP

Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

**Kit Contents** 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

HP 9.5mm Slim BDXL Blu- Description **Ray Writer** 

9.5mm height, tray-load

**Mounting Orientation** 

Either horizontal or vertical

**Interface Type** 

SATA/ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

**Supported Media Types** 

**BD-ROM** 

BD-R **BD-RE DVD-RAM** DVD+R DVD+RW

DVD+R DL DVD-R DL

DVD-R DVD-RW CD-R CD-RW

**Disc Capacity** DVD-ROM 8.5 GB DL or 4.7 GB standard

> Blu-ray 25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

**Full Stroke DVD** < 230 ms (seek) < 220 ms (seek) Full Stroke CD

Blu-ray < 230 ms (seek) (Full Stroke Blu-ray) Startup Time (Time to drive ready from tray

loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) **25S / 25S** 

DVD-RW **25S** 

DVD+R (SL/DL) 25S / 25S

**25S** DVD+RW DVD-RAM **45S** CD-ROM **15S** 

Maximum Data Transfer CD ROM Read

Rates

**DVD ROM Read** 

CD-RW Up to 24X

CD-ROM, CD-R Up to 24X

DVD-RAM Up to 8X DVD+RW Up to 8X DVD-RW Up to 8X

DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

BD-ROM Up to 6X Blu-ray

BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X

**Power** Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p **DC Current** 5 VDC -900 mA typical, 2000mA

> > maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-Relative Humidity 10% to 80% condensing) Maximum Wet Bulb Temperature 84° F (29° C)

**Operating Systems** Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

Supported and 64-bit,

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or Windows XP

Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP DX115 Removable Drive Enclosure

**Interface Type** Compatible with SAS or SATA controllers. Offers 6Gb/s performance when

used with 6Gb/s HDDs.

**Dimensions** (WxHxD) 147.6mm W x 41.1mm H x 205mm D

(5.81" W x 1.62" H x 8.08" D)

**Approvals** Frame and Carrier: 1.73 kg (3.8 lbs.)

Carrier: 0.45 kg (1 lbs.)

HP 15-in-1 Media Card Reader **Description** Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode Supports MS-PRO 4-bit parallel transfer mode Supports MS PRO-HG Duo 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode Supports UHS-104 SD 4-bit card (version 3.0)

Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode

Interface Type USB 3.0 High-speed interface

**Note:** If there is a USB2 connection, USB2 transfer speeds are supported.

**Dimensions** (WxHxD) 4.9 x 4 x 1 in (124.5 x 101.6 x 25.4 mm) Fits conveniently in the 5.25" drive

bay.

Supported Media Types CompactFlash Type I

CompactFlash Type II

Microdrive

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)
SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

Memory Stick Memory Stick Select Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo MagicGate Memory Stick (MG)

MagicGate Memory Stick Duo

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

## Test Parameters/Conditions - Power applied, unit operating on system

±5%

Operating Systems
Supported

Windows 8 Pro (64-bit)\* Windows 8.1 (64-bit)\* Windows 8 (64-bit)\*

Windows 7 Ultimate (32-bit)\*\* Windows 7 Ultimate (64-bit)\*\* Windows 7 Professional (32-bit)\*\* Windows 7 Professional (64-bit)\*\*

Windows 7 Home Basic\*\*

Windows 7 Home Premium (32-bit)\*\* Windows 7 Home Premium (64-bit)\*\*

Windows Vista Business 64 Windows Vista Business 32 Windows Vista Home Basic 32 Windows XP Professional Windows XP Home 32

No driver is required for this device. Native support is provided by the operating system.

Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See

http://www.microsoft.com.

Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality.

See<a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for details.

Kit Contents Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security

Software and Documentation CD

**Approvals** USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0.

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

**Weight** 0.35 lbs. (0.16 kg)

## Technical Specifications - Controller Cards

### **CONTROLLER CARDS**

**HP IEEE 1394b FireWire PCIe Card** 

**Data Transfer Rate** Supports up to 800 Mb/s **Devices Supported** IEEE-1394 compliant devices **Bus Type** PCIe card full height PCIe slots

**Ports** Two IEEE-1394b external 9-Pin connectors (Rear)

One 10-Pin header connector **Internal Connectors** 

Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit, SLED 11 **System Requirements** 

and RHEL 6. Intel i5 series or higher processor, min 2GB of RAM, 20GB Hard

Drive, CD-ROM drive, built in sound system, Available PCIe slot.

**Temperature - Operating** 50° to 131° F (10° to 55° C) Temperature - Storage -22° to 140° F (-30° to 60° C)

**Relative Humidity -**

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit

**HP Thunderbolt-2 PCIe 1- Data Transfer Rate** 

port I/O Card

Supports up to 20 Gb/s (20,000 Mb/s)

**Devices Supported** Thunderbolt™ certified devices

**Bus Type** PCIe card, full or half height PCIe slots

**Ports** One Thunderbolt™ 2 external 20-Pin output connectors (Rear)

One full size DisplayPort input connector (Rear)

**Internal Connectors** One 5-Pin header connector

**System Requirements** 

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel

i5 series or higher processor, 4-GB RAM, 20-GB Hard Drive, available PCIe

slot.

**Temperature - Operating** 50° to 131° F (10° to 55° C) Temperature - Storage -22° to 140° F (-30° to 60° C)

**Relative Humidity -**

**Operating** 

20% to 80%

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Compliances

Taiwan BSMI CNS13438, Korea MIC

**Operating Systems** 

**Supported** 

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.

**Kit Contents** HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height

bracket, DisplayPort to DisplayPort cable, internal header cables (2), user

documentation and warranty card.

## Technical Specifications - Networking and Communications

### **NETWORKING AND COMMUNICATIONS**

Integrated Intel I218LM **PCIe GbE Controller** 

Connector RJ-45 (motherboard integration)

Controller Intel I218LM GbE platform LAN connect networking controller

Memory 3 KB FIFO packet buffer memory (both Tx and Rx)

**Data Rates Supported** 10/100/1000 Mbps

Compliance 802.1as, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3x,

802.3z

**Bus Architecture** PCI Express 1.1 (x1) and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

**Power Requirement** Requires 3.3V only (integrated regulators)

**Boot ROM Support** Yes

**Network Transfer Mode** Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

**Network Transfer Rate** 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostics

AMT 9.1 support, vPro compliant

HP X520 10GbE Dual Port Hardware Certifications

Adapter

FCC B, UL, CE, VCCI, BSMI, CTICK, KCC

**HP 10GbE SFP+ SR** 

**Transceiver** 

**Operating Temperature** 

**Operating Humidity** 

0% to 85%, noncondensing **Dimensions**  $(H \times W \times D)$ 

0.47(h) x 0.54(w) x 2.19(d)inches

(1.19 x 1.38 x 5.57 cm)

0°C to 45°C (32°F to 113°F)

**HP 361T PCIe Dual Port Gigabit NIC** 

**Connector** 

Two RJ-45

Controller

Compliance

Intel® Ethernet I350 Controller

**Data Rates Supported** 

10/100/1000 Mbps, Half- and full-duplex

802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.10, 802.3az, IEEE

1588

PCIe v2.0 standard RoHS (6 of 6) FCC (U.S. only) Class B DOC (Canada) Class B

CE EN 55024, EN55022 Class B

VCCI Class II **UL 1950** 

**CSA 950** EN 60950 CE **ACPI 1.1a** 

Microsoft WHQL (Windows Hardware Quality Labs)

**Data Path Width** Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express

slots



## Technical Specifications - Networking and Communications

**Power Requirement** 4.1W idle without EEE link partner

3.2W idle with EEE link partner

4.2W maximum

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature

**Operating Humidity** 

10% to 95% non-condensing

32° to 131°F (0° to 55° C)

**Dimensions**  $(H \times W \times D)$ 

5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)

**Operating System Driver** 

Support

Windows 7 Professional 32-bit and 64-bit.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

**Kit Contents** HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket

attached to it (the low profile bracket is included in the clamshell that the

PCA ships in)

Product Warranty statement and the Quick Install Card (QIC).

Intel 7260 802.11 a/b/g/n PCIe WLAN NIC **Operating Humidity** 

Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Dimensions** (H x W x D)

Native HMC: 26.8 x 30.0 x 2.4 mm

Carrier Card Assembly 3.3 x 4.7 in (84 x 119 mm)

**Kit Contents** 

 $\label{pcle} {\bf PCIe}~{\bf x1}~{\bf card}~{\bf with}~{\bf full}~{\bf height}~{\bf bracket}, {\bf rf}~{\bf antenna}, {\bf antenna}~{\bf cable}, {\bf separate}$ 

low profile bracket, software CD and warranty.

Notes

- WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.
- Check latest software/driver release for updates on supported security features.
- 3. Maximum output power may vary by country according to local regulations.
- 4. In Power Save Polling mode and on battery power.
- Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



## **Summary of Changes**

## **SUMMARY OF CHANGES**

Date of change:	Version History:		Description of change:
August 21	V1	Added	Style and technical specifications
October 1, 2014	From v1 to v2	Added	Rack dimensions, note to supported components: memory, Foxit PhantomPDF Express and Cyberlink Power2Go: software, Optical drives: DVD, BD-XL specs
		Changed	Turbo specs for E5-1660v3, Acoustics - only 1 ODD on the high-end config, not 2, Declared Noise Emissions section, Supported Components: Graphics, Optical and Removable Storage, Overview, Stable & Consistent, power supply configurations, Noise Emissions section, Updated Power Supply Configurations and table
		Removed	Cyberlink MediaSuite, TPM 2.0 references, HP Power Assistant and PDF Complete



## **Technical Specifications**

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